



# Material Composition Declaration

© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.

This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
------------	--	---------------------------	--

## Supplier Information

Company Name * IDT Inc.	Company Unique ID	Unique ID Authority	Response Date * 2009-08-07	Response Document ID BGG313				
Contact Name * CS Phek	Title - Contact Engineer	Phone - Contact * 604-613-2538	Email - Contact * csphek@idt.com	Duplicate Contact -> Authorized Representative				
Authorized Representative * CS Phek	Title - Representative Engineer	Phone - Representative * 604-613-2538	Email - Representative * csphek@idt.com	Supplier Comments or URL for Additional Information				
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
		BGG313	2009-08-07	0	ASEK	4,048.22	mg	Each
Alternate Recommendation				Alternate Item Comments				

## Manufacturing Process Information

Terminal Plating / Grid Array Material Tin/Silver/Copper (Sn/Ag/Cu)	Terminal Base Alloy Not Applicable	J-STD-020 MSL Rating 3	Peak Process Body Temperature 260 C	Max Time at Peak Temperature 30 seconds	Number of Reflow Cycles 3
--	---------------------------------------	---------------------------	--	--	------------------------------

Comments

Save the fields in this form to a file

Export Data

Import fields from a file into this form

Import Data

Clear all of the fields on this form

Reset Form

Lock the fields on this form to prevent changes

Lock Supplier Fields

## RoHS Material Composition Declaration

Declaration Type \*

Simplified

**RoHS Directive 2002/95/EC** **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

**RoHS Declaration \*** 1 - Item(s) does not contain RoHS restricted substances per the definition above

**Supplier Acceptance \*** Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

## Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

+I	-I	Item/SubItem Name	+M	-M	Homogeneous Material	Weight	Unit of Measure	+C	-C	Level	Substance Category	+S	-S	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
																			-	+	
		BGG313			Encapsulant	1,827	mg			Supplier	Filler			Fused Silica	60676-86-0		1,626.03	mg	0.02	0.02	401,66
										Supplier	Binder			Polymeric Resin	Trade Secre		197.32	mg			48,741
										Supplier	Coloring			Carbon Black	1333-86-4		3.65	mg			903
					Die Attach Adhes	7.33	mg			Supplier	Filler			Silver	7440-22-4		5.68	mg			1,403
										Supplier	Binder			Polymeric Resin	Trade Secre		0.37	mg			91
										Supplier	Binder			Functionalized Ester	Trade Secre		0.37	mg			91
										Supplier	Binder			Diester	Trade Secre		0.92	mg			226
					Substrate	1,513	mg			Supplier	Conductive			Copper	7440-50-8		267.65	mg			66,115
										Supplier	Non Conductive			Core Material	Trade Secre		498.38	mg			123,11
										Supplier	Non Conductive			Prepreg	Trade Secre		616.7	mg			152,33
										Supplier	Non Conductive			Solder Mask	Trade Secre		110.15	mg			27,209
										Supplier	Plating			Nickel (Use Internal On	7440-02-00		16.49	mg			4,074
										Supplier	Plating			Gold	7440-57-5		3.63	mg			897
					Solder Ball	582	mg			Supplier	Metal			Tin	7440-31-5		561.63	mg			138,73
										Supplier	Metal			Silver	7440-22-4		17.46	mg			4,313
										Supplier	Metal			Copper	7440-50-8		2.91	mg			719
					Bond Wire	74.89	mg			Supplier	Wire			Gold	7440-57-5		74.89	mg			18,499
					Silicon Chip	44	mg			Supplier	Silicon			Silicon	7440-21-3		44	mg			10,869